

**AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**LISTING OF CLAIMS:**

1. (Currently Amended) A laminate of magnetic substrates comprising, wherein each magnetic substrate comprises a high molecular compound layer and a magnetic metal thin plate, wherein the magnetic metal thin plates in the laminate metals partially come into contact with one another, between the thin plates and wherein the volume resistivity defined in JIS H 0505 in a direction perpendicular to anthe adhesive surface of the laminate is from 0.1 to less than  $10^8 \Omega\text{cm}$ .
2. (Original) The laminate of magnetic substrates according to claim 1, wherein the high molecular compound layer covers not less than 50% of the area of an adhesive surface of the magnetic metal thin plate and the volume resistivity defined in JIS H 0505 in a direction perpendicular to the adhesive surface of the laminate is from  $1 \Omega\text{cm}$  to  $10^6 \Omega\text{cm}$ .
3. (Currently Amended) The laminate of magnetic substrates according to claim 1, wherein two or more kinds of magnetic metal thin plate plates are used as the magnetic metal thin plate plates constituting [[a]] the magnetic substrate substrates for use in the laminate of magnetic substrates.
4. (Currently Amended) The laminate of magnetic substrates according to claim 1, wherein the magnetic metal thin plate is made of plates include at least two kinds of metals

selected from the group consisting of an amorphous metal plate, a nano crystal magnetic metal plate or and a silicon steel sheet.

5. (Currently Amended) The laminate of magnetic substrates according to claim 3, wherein the magnetic metal thin plate ~~is made of plates include~~ an amorphous metal plate and a silicon steel sheet.

6. (Currently Amended) A method of manufacturing the laminate of magnetic substrates of claim 1, wherein two or more sheets of the magnetic substrates comprising the high molecular compound layer and the magnetic metal thin plate are stacked and pressure of from 0.2 to 100 MPa is applied thereto such that the metals magnetic metal thin plates partially come into contact with one another between the thin plates.

7. (Original) A method of manufacturing the laminate of magnetic substrates of claim 1 obtained by coating not less than 50% of the area of the magnetic metal thin plate with the high molecular compound and then drying, punching the magnetic metal thin plates obtained, stacking them and subjecting them to plastic deformation, and heating the resulting magnetic metal thin plates while applying pressure of from 0.2 to 100 MPa for an integrated lamination.

8. (Original) The method of manufacturing the laminate of magnetic substrates according to claim 7, wherein the method of subjecting to plastic deformation is a caulking process.

9. (Previously Presented) The laminate of magnetic substrates according to claim 3, wherein the laminate of magnetic substrates is used for any of a transformer, an inductor and an antenna.

10. (Previously Presented) The laminate of magnetic substrates according to claim 3, wherein the laminate of magnetic substrates is used for a magnetic core material of a stator or a rotor of a motor or a generator.

11. (Previously Presented) The laminate of magnetic substrates according to claim 1, wherein the laminate of magnetic substrates is used for any of a transformer, an inductor and an antenna.

12. (Previously Presented) The laminate of magnetic substrates according to claim 1, wherein the laminate of magnetic substrates is used for a magnetic core material of a stator or a rotor of a motor or a generator.